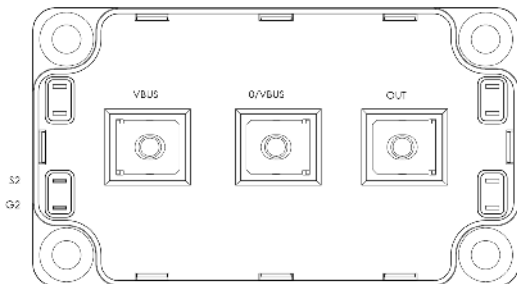
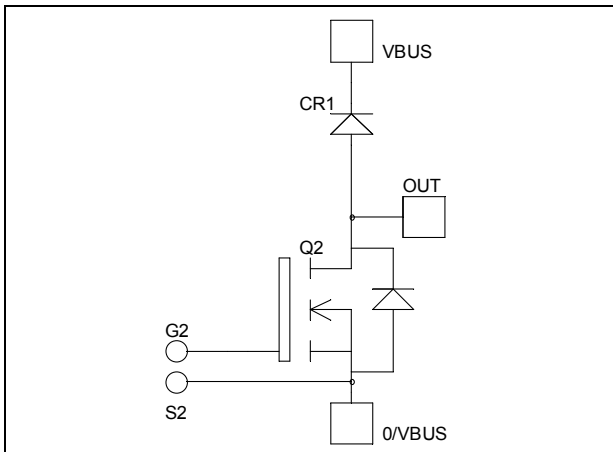


Boost chopper MOSFET Power Module

$V_{DSS} = 1000V$
 $R_{DSon} = 90m\Omega \text{ typ @ } T_j = 25^\circ C$
 $I_D = 78A \text{ @ } T_c = 25^\circ C$



Application

- AC and DC motor control
- Switched Mode Power Supplies
- Power Factor Correction

Features


- Power MOS 7[®] MOSFETs
 - Low R_{DSon}
 - Low input and Miller capacitance
 - Low gate charge
 - Avalanche energy rated
 - Very rugged
- Kelvin source for easy drive
- Very low stray inductance
 - Symmetrical design
 - M5 power connectors
- High level of integration

Benefits

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Low profile
- RoHS Compliant

Absolute maximum ratings

| Symbol | Parameter | Max ratings | Unit |
|------------|---|--------------------|-----------|
| V_{DSS} | Drain - Source Breakdown Voltage | 1000 | V |
| I_D | Continuous Drain Current | $T_c = 25^\circ C$ | 78 |
| | | $T_c = 80^\circ C$ | 59 |
| I_{DM} | Pulsed Drain current | 312 | |
| V_{GS} | Gate - Source Voltage | ± 30 | V |
| R_{DSon} | Drain - Source ON Resistance | 105 | $m\Omega$ |
| P_D | Maximum Power Dissipation | $T_c = 25^\circ C$ | 1250 |
| I_{AR} | Avalanche current (repetitive and non repetitive) | 25 | A |
| E_{AR} | Repetitive Avalanche Energy | 50 | mJ |
| E_{AS} | Single Pulse Avalanche Energy | 3000 | |

 **CAUTION:** These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com

All ratings @ $T_j = 25^\circ\text{C}$ unless otherwise specified

Electrical Characteristics

| Symbol | Characteristic | Test Conditions | Min | Typ | Max | Unit |
|--------------|---------------------------------|--------------------------------------|--------------------------|-----|-----------|------------------|
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{GS} = 0V, V_{DS} = 1000V$ | | | 400 | μA |
| | | $V_{GS} = 0V, V_{DS} = 800V$ | $T_j = 25^\circ\text{C}$ | | 2000 | |
| $R_{DS(on)}$ | Drain – Source on Resistance | $V_{GS} = 10V, I_D = 39A$ | | 90 | 105 | $\text{m}\Omega$ |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{GS} = V_{DS}, I_D = 10\text{mA}$ | 3 | | 5 | V |
| I_{GSS} | Gate – Source Leakage Current | $V_{GS} = \pm 30V, V_{DS} = 0V$ | | | ± 250 | nA |

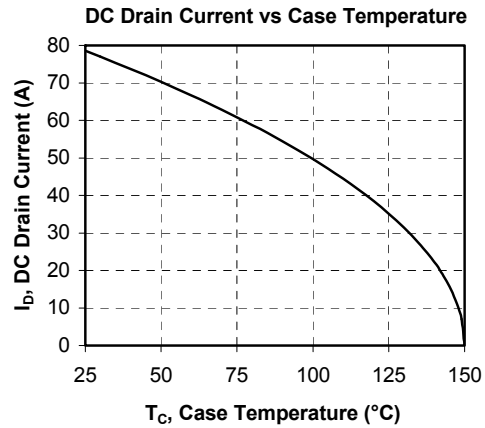
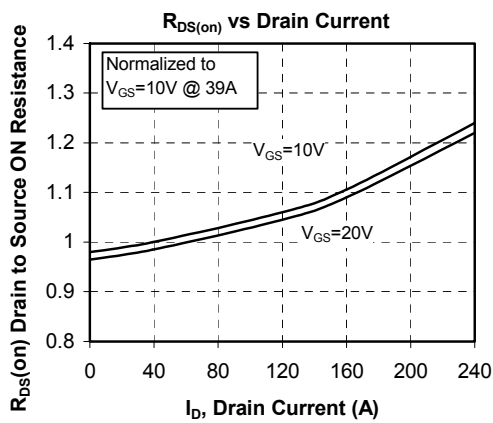
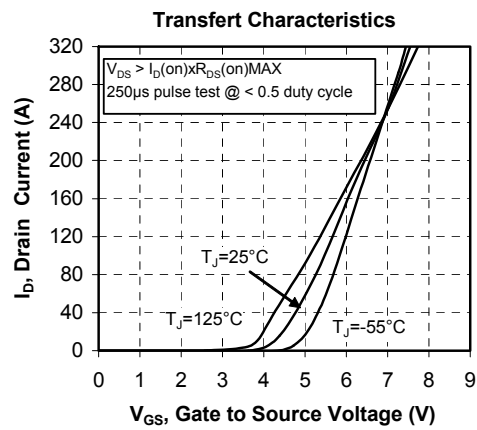
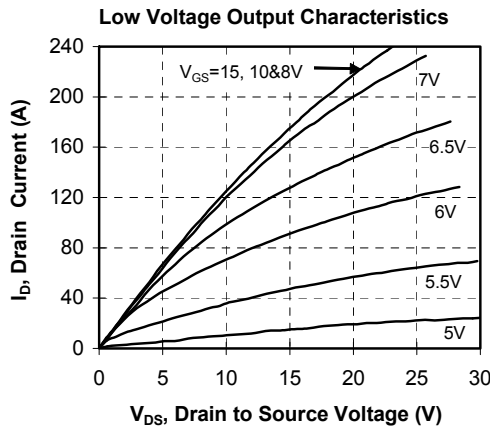
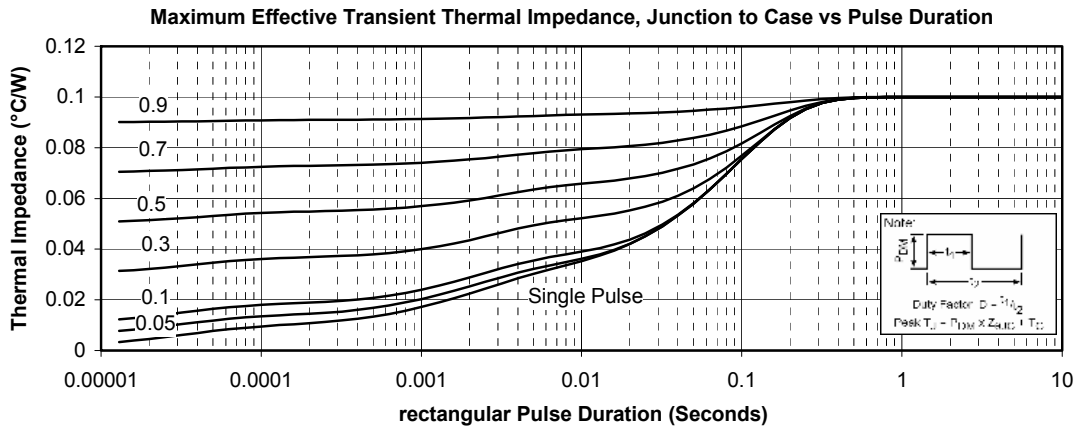
Dynamic Characteristics

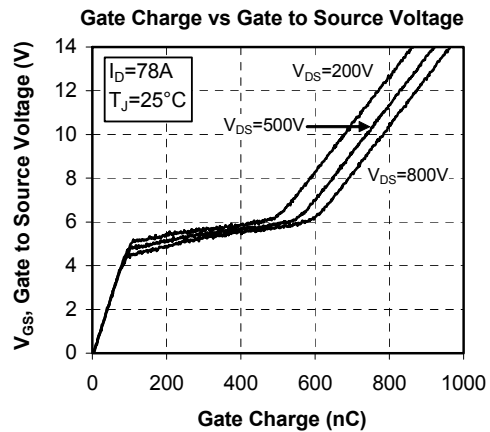
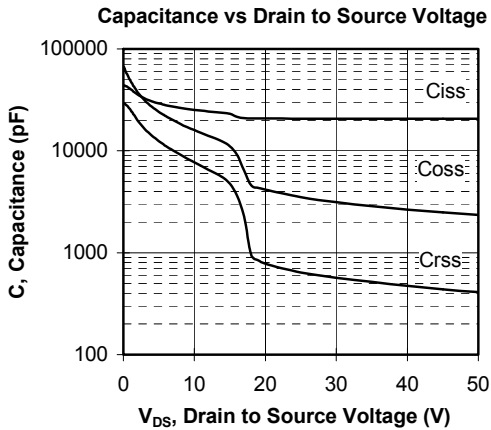
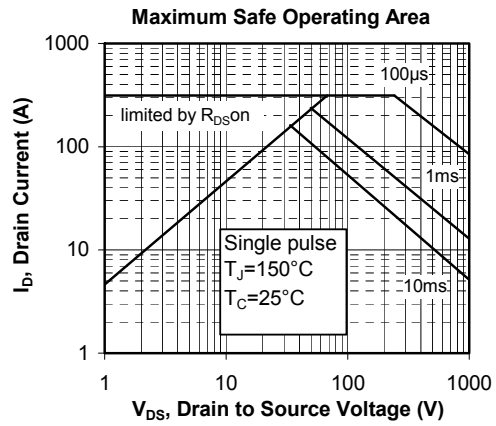
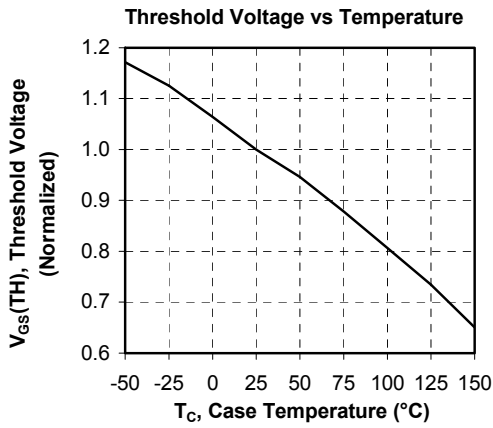
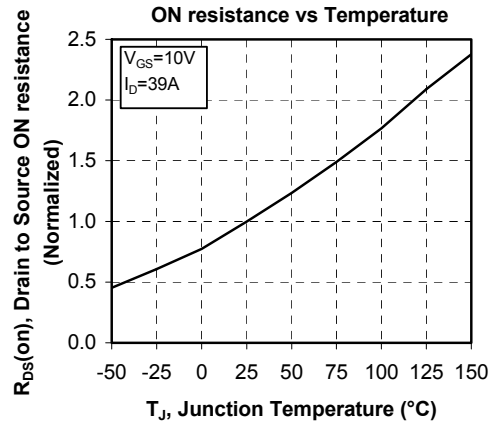
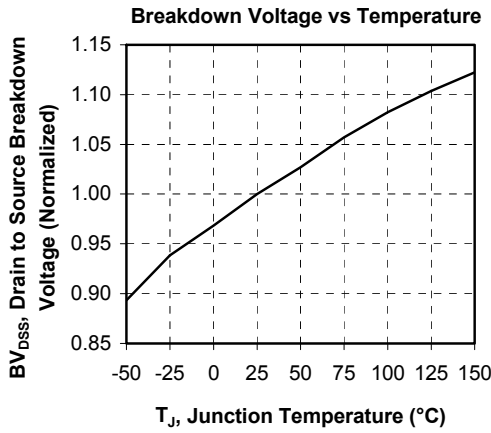
| Symbol | Characteristic | Test Conditions | Min | Typ | Max | Unit |
|--------------|------------------------------|---|-----|------|-----|-------------|
| C_{iss} | Input Capacitance | $V_{GS} = 0V$ $V_{DS} = 25V$ $f = 1\text{MHz}$ | | 20.7 | | nF |
| C_{oss} | Output Capacitance | | | 3.5 | | |
| C_{rss} | Reverse Transfer Capacitance | | | 0.64 | | |
| Q_g | Total gate Charge | $V_{GS} = 10V$ $V_{Bus} = 500V$ $I_D = 78A$ | | 744 | | nC |
| Q_{gs} | Gate – Source Charge | | | 96 | | |
| Q_{gd} | Gate – Drain Charge | | | 488 | | |
| $T_{d(on)}$ | Turn-on Delay Time | Inductive switching @ 125°C $V_{GS} = 15V$ $V_{Bus} = 670V$ $I_D = 78A$ $R_G = 1.2\Omega$ | | 18 | | ns |
| T_r | Rise Time | | | 12 | | |
| $T_{d(off)}$ | Turn-off Delay Time | | | 155 | | |
| T_f | Fall Time | | | 40 | | |
| E_{on} | Turn-on Switching Energy | Inductive switching @ 25°C $V_{GS} = 15V, V_{Bus} = 670V$ $I_D = 78A, R_G = 1.2\Omega$ | | 3.6 | | mJ |
| E_{off} | Turn-off Switching Energy | | | 2.5 | | |
| E_{on} | Turn-on Switching Energy | Inductive switching @ 125°C $V_{GS} = 15V, V_{Bus} = 670V$ $I_D = 78A, R_G = 1.2\Omega$ | | 5.7 | | mJ |
| E_{off} | Turn-off Switching Energy | | | 3.1 | | |

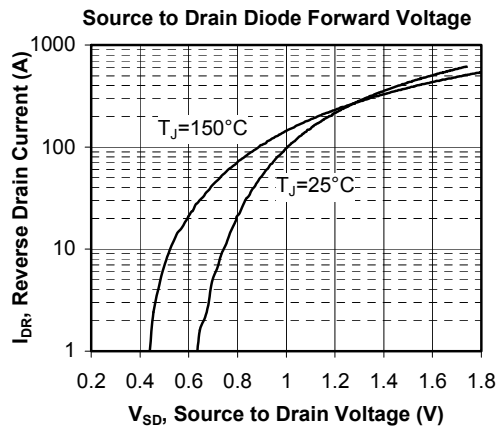
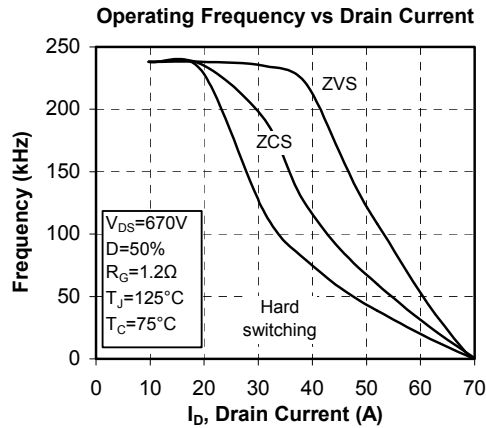
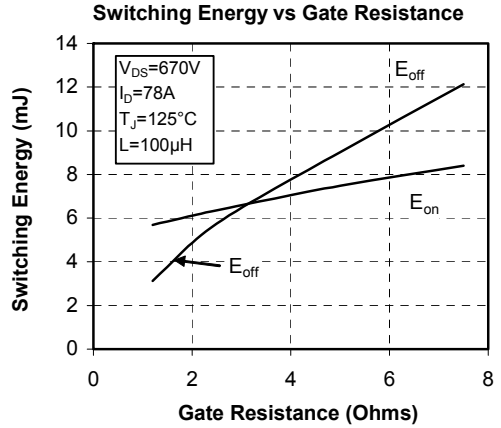
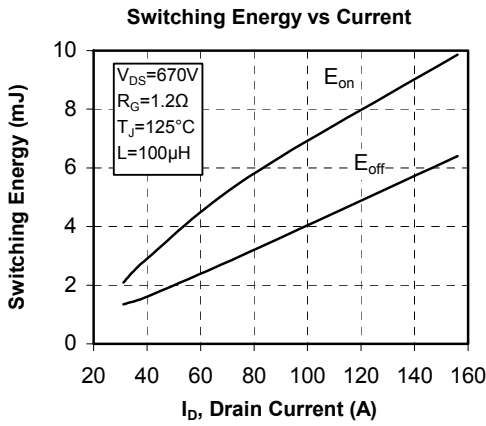
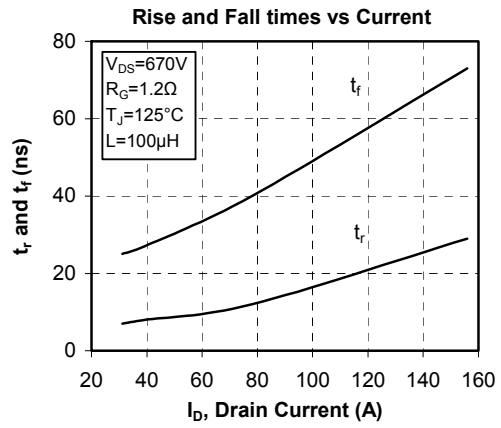
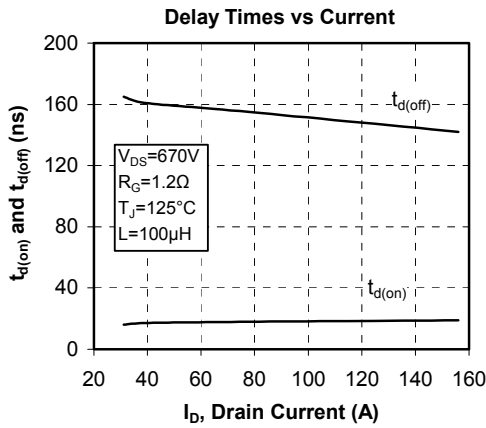
Chopper diode ratings and characteristics

| Symbol | Characteristic | Test Conditions | Min | Typ | Max | Unit |
|-----------|---|--|---------------------------|-----|------|---------------|
| V_{RRM} | Maximum Peak Repetitive Reverse Voltage | | 1000 | | | V |
| I_{RM} | Maximum Reverse Leakage Current | $V_R = 1000V$ | $T_j = 25^\circ\text{C}$ | | 250 | μA |
| | | | $T_j = 125^\circ\text{C}$ | | 500 | |
| I_F | DC Forward Current | $T_c = 70^\circ\text{C}$ | | 100 | | A |
| V_F | Diode Forward Voltage | $I_F = 100A$ | | 1.9 | 2.5 | V |
| | | $I_F = 200A$ | | 2.2 | | |
| | | $I_F = 100A$ | $T_j = 125^\circ\text{C}$ | | 1.7 | |
| t_{rr} | Reverse Recovery Time | $I_F = 100A$ $V_R = 670V$ $di/dt = 200A/\mu\text{s}$ | $T_j = 25^\circ\text{C}$ | | 300 | ns |
| | | | $T_j = 125^\circ\text{C}$ | | 360 | |
| Q_{rr} | Reverse Recovery Charge | | $T_j = 25^\circ\text{C}$ | | 800 | nC |
| | | | $T_j = 125^\circ\text{C}$ | | 4050 | |

Typical Performance Curve







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